

High Temperature Silicon Carbide Power Schottky Diode

V_{RRM} = 300 V $I_{F (Tc=25^{\circ}C)}$ = 4 A Q_{C} = 9 nC

Features

- 300 V Schottky rectifier
- 210 °C maximum operating temperature
- Zero reverse recovery charge
- · Superior surge current capability
- Positive temperature coefficient of V_F
- Temperature independent switching behavior
- Lowest figure of merit Q_C/I_E
- Available screened to Mil-PRF-19500

Package

• RoHS Compliant





TO - 46

Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- · Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- · Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

Applications

- Down Hole Oil Drilling
- Geothermal Instrumentation
- Solenoid Actuators
- General Purpose High-Temperature Switching
- Amplifiers
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)

Maximum Ratings at T_i = 210 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V_{RRM}		300	V
Continuous forward current	I _F	T _C = 25 °C	4	Α
Continuous forward current	I _F	T _C ≤ 180 °C	2	Α
RMS forward current	I _{F(RMS)}	T _C ≤ 180 °C	4	Α
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	T_{C} = 25 °C, t_{P} = 10 ms	10	Α
Non-repetitive peak forward current	$I_{F,max}$	$T_C = 25 ^{\circ}\text{C}, t_P = 10 \mu\text{s}$	65	Α
I ² t value	∫i² dt	$T_{\rm C}$ = 25 °C, $t_{\rm P}$ = 10 ms	0.5	A^2S
Power dissipation	P_{tot}	T _C = 25 °C	64	W
Operating and storage temperature	T_j , T_stg		-55 to 210	°C

Electrical Characteristics at T_i = 210 °C, unless otherwise specified

Parameter	Symbol	Conditions		Values		Unit	
	Зуньы			min.	typ.	max.	Offic
Diode forward voltage	V _F	I _F = 1 A, T _j = 25 °C		1.6		V	
Diode forward voltage		I _F = 1 A, T _j = 210 °C		2.6			
Reverse current	I_R	$V_R = 300 \text{ V}, T_j = 25 ^{\circ}\text{C}$		1	5	μΑ	
Neverse current		$V_R = 300 \text{ V}, T_j = 210 ^{\circ}\text{C}$		5	50		
Total capacitive charge	Q _c	$I_F \le I_{F,MAX}$ $dI_F/dt = 200 \text{ A/µs}$	V _R = 300 V		9		nC
Switching time	t _s	$T_i = 210 ^{\circ}\text{C}$	V _R = 300 V		< 17		ns
Total capacitance	С	$V_R = 1 \text{ V, } f = 1 \text{ MHz, } T_j = 25 \text{ °C}$ $V_R = 300 \text{ V, } f = 1 \text{ MHz, } T_j = 25 \text{ °C}$		76		pF	
					15		рг

Thermal Characteristics

Thermal resistance, junction - case

Mechanical Properties			
Mounting torque	M	0.6	Nm

 $R_{th,IC}$

°C/W

5.55



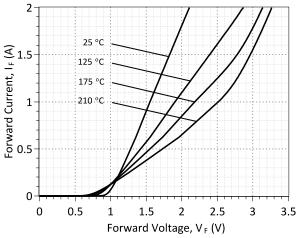


Figure 1: Typical Forward Characteristics

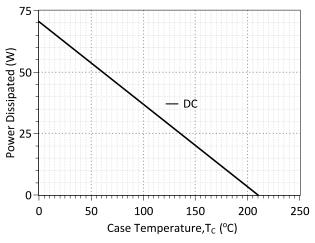


Figure 3: Power Derating Curve

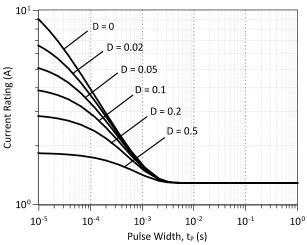


Figure 5: Current vs Pulse Duration Curves at T_c = 190 °C

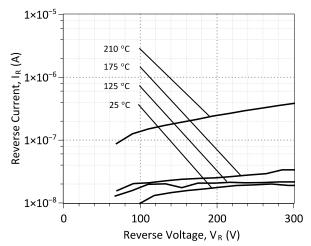


Figure 2: Typical Reverse Characteristics

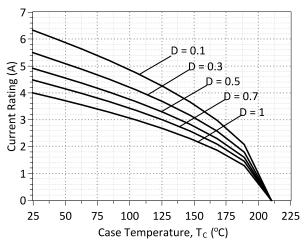


Figure 4: Current Derating Curves (D = t_p/T , t_p = 400 μ s) (Considering worst case Z_{th} conditions)

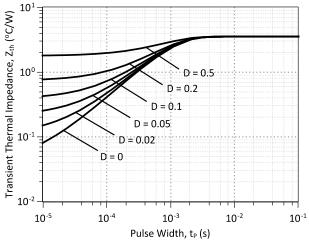


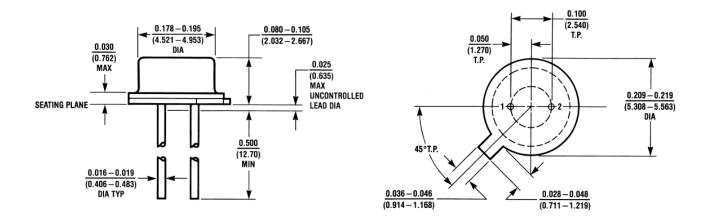
Figure 6: Transient Thermal Impedance



Package Dimensions:

TO-46

PACKAGE OUTLINE



NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

Revision History					
Date	Revision	Comments	Supersedes		
2014/08/29	0	Initial release			

Published by GeneSiC Semiconductor, Inc. 43670 Trade Center Place Suite 155 Dulles, VA 20166

GeneSiC Semiconductor, Inc. reserves right to make changes to the product specifications and data in this document without notice.

GeneSiC disclaims all and any warranty and liability arising out of use or application of any product. No license, express or implied to any intellectual property rights is granted by this document.

Unless otherwise expressly indicated, GeneSiC products are not designed, tested or authorized for use in life-saving, medical, aircraft navigation, communication, air traffic control and weapons systems, nor in applications where their failure may result in death, personal injury and/or property damage.



SPICE Model Parameters

This is a secure document. Copy this code from the SPICE model PDF file on our website into a SPICE software program for simulation of the GB02SHT03-46.

```
MODEL OF GeneSiC Semiconductor Inc.
     $Revision: 1.0
                                $
     $Date: 29-AUG-2014
                                $
    GeneSiC Semiconductor Inc.
     43670 Trade Center Place Ste. 155
    Dulles, VA 20166
    COPYRIGHT (C) 2014 GeneSiC Semiconductor Inc.
     ALL RIGHTS RESERVED
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
* Start of GB02SHT03-46 SPICE Model
.SUBCKT GB02SHT03ANODE KATHODE
D1 ANODE KATHODE GB02SHT03 25C; Call the Schottky Diode Model
D2 ANODE KATHODE GB02SHT03 PIN; Call the PiN Diode Model
.MODEL GB02SHT03 25C D
+ IS
       3.57E-18
                                      0.49751
                           RS
+ TRS1
          0.0057
                          TRS2
                                      2.40E-05
         1
+ N
                          IKF
                                     322
+ EG
         1.2
                          XTI
         9.12E-11
                                      0.371817384
+ CJO
                          VJ
         1.527759838
+ M
                         FC
                                     0.5
+ TT
         1.00E-10
                                      300
                          BV
          1.00E-03
                           VPK
                                      300
+ IBV
                                      SiC Schottky
+ IAVE
                           TYPE
+ MFG
         GeneSiC Semiconductor
.MODEL GB02SHT03 PIN D
+ IS
      5.73E-11
                           RS
                                      0.72994
+ N
                           IKF
                                     800
+ EG
          3.23
                                      -14
                          XTI
+ FC
          0.5
                          TT
+ BV
          300
                           IBV
                                      1.00E-03
          300
+ VPK
                           IAVE
+ TYPE
          SiC PiN
.ENDS
```

* End of GB02SHT03 SPICE Model

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Schottky Diodes & Rectifiers category:

Click to view products by GeneSiC Semiconductor manufacturer:

Other Similar products are found below:

MA4E2039 D1FH3-5063 MBR0530L-TP MBR10100CT-BP MBR1545CT MMBD301M3T5G RB160M-50TR RB551V-30

BAS16E6433HTMA1 BAT 54-02LRH E6327 NSR05F40QNXT5G JANS1N6640 SB07-03C-TB-H SB1003M3-TL-W SK310-T SK32A
LTP SK34B-TP SS3003CH-TL-E GA01SHT18 CRS10I30A(TE85L,QM MA4E2501L-1290 MBRB30H30CT-1G SB007-03C-TB-E

SK32A-TP SK33B-TP SK38B-TP NRVBM120LT1G NTE505 NTSB30U100CT-1G SS15E-TP VS-6CWQ10FNHM3 ACDBA1100LR-HF

ACDBA1200-HF ACDBA140-HF ACDBA2100-HF ACDBA3100-HF CDBQC0530L-HF CDBQC0240LR-HF ACDBA260LR-HF

ACDBA1100-HF SK310B-TP MA4E2502L-1246 MA4E2502H-1246 NRVBM120ET1G NSR01L30MXT5G SB560 PMAD1108-LF

SD103ATW-TP 1N5819T-G PDS1040Q-13